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3M-NANO is the annual International Conference on Manipulation, Manufacturing and Measurement on the Nanoscale. It will be held on 31 July - 4 August 2023 in Chengdu, China. **The ultimate ambition of this conference series is to bridge the gap between nanosciences and engineering sciences**, aiming at technology opportunities and new markets. The advanced technologies for manipulation, manufacturing and measurement at nanoscale promise novel revolutionary products and methods in numerous areas of application. Scientists working in research fields related to 3M-NANO topics are invited to submit papers. **All accepted full papers (presented at the conference and following IEEE format) will be submitted in IEEE Xplore database and Ei Compendex.** Selected papers will be recommended for publication in the IEEE Trans. on Automation Science & Engineering, Int. J of Nanomanufacturing, IFAC Mechatronics, Int. J of Optomechatronics, J of Micro-Bio Robotics, Journal of Bionic Engineering, Light (Science & Applications), Optics and Precision Engineering and other SCI/Ei journals.

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Topics: Specific topics include, but are not limited to

Nanohandling robots and systems
Nanofabrication and nanoassembly
Nanometrology and nanocharacterization
Nanopositioning and nanomanipulation
Nanosensing and microscopy
AFM and SEM for nanohandling
Process automation at nanoscale
Self-assembly at nanoscale
Nanoscale robotics
Nanolithography

Nanoenergy
Nanoscience for healthy foods
3D/4D printing and applications

Nanomaterials and applications
Graphene, 2D materials and applications
Nanoparticles, nanowires and nanotubes
Nanoelectronics and nanomagnetics
Nanophotonics and plasmonics
Nanomechanics and nanomechatronics
NEMS and their applications
Nanofluidics
DNA detection and sequencing
Bio-nano devices and applications
Bio-nanoimaging and nanomeasurement
Nanotech and environmental protection

High-profile keynote talks (20-24) on selected topics in manipulation, manufacturing and measurement on the nanoscale will be offered by **distinguished international experts**.

Social events: 3M-NANO aims at encouraging long-term partnerships and collaborative activities between experts in nanosciences and in engineering sciences. Get-together events will be organized by 3M-NANO as part of this effort.

Venue: Chéngdū, formerly transliterated as Chengdu, is the capital of Sichuan province, of Southwest China, maintaining sub-provincial administrative status. Chengdu is also one of the most important economic centres, transportation and communication hubs in Western China. Chengdu is located at the western edge of the Sichuan Basin and sits on the Chengdu Plain; the dominating terrain is plains. Sichuan cuisine is a style of Chinese cuisine originating in the Sichuan Province of Southwestern China famed for bold flavors. UNESCO has declared the city of Chengdu to be a city of Gastronomy in 2011, mainly because of its Sichuan style of cooking.

Important Dates

Full paper submission: 1 June 2023 Proposals for special session (5-6 papers): 1 June 2023



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